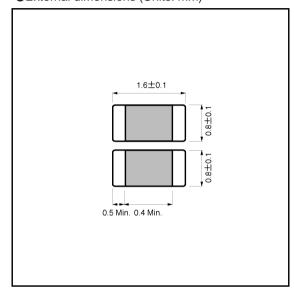
# Multi-layer ceramic chip capacitors MCH18 (1608 (0603) size, chip capacitor)

#### Features

- 1) Small size (1.6 x 0.8 x 0.8 mm) makes it perfect for lightweight portable devices.
- 2) Comes packed either in tape to enable automatic mounting or in bulk cases.
- 3) Precise uniformity of shape and dimensions facilitates highly efficient automatic mounting.
- 4) Solder-coated terminals offer superior solder bility and resistance to soldering heat.

# Structure External electrode III (solder-coated layer) Internal electrode External electrode II (barrier layer)

External dimensions (Units: mm)



### Product designation

Ceramic element

Code	Product thickness	Packaging specifications	Reel	Basic ordering (pcs.)
K	0.8mm	Paper tape (width 8 mm, pitch 4 mm)	<b>ø</b> 180mm (7in.)	4,000
L	0.8mm	Paper tape (width 8 mm, pitch 4 mm)	φ330mm (13in.)	16,000
С	0.8mm	Bulk case	_	15,000

Reel (\$\phi180,\$\phi330mm): compatible with EIAJ ETX-7001 Bulk case: according to EIAJ ET-7201A

Packaging style

Part No. Rated voltage Capacitance-temperature characteristics Nominal Capacitance tolerance Code EIA code Operating temperature (°C) Temp. coefficient or percent change capacitance Code Voltage Code tolerance 2 25V  $\pm 0.25 pF (0.5 \sim 5 pF)$ 3 16V COG -55 to +1250±30ppm / °C D ±0.5pF(5.1~10pF) 50V 3-digit designation 5 ±5% (11pF or more) -55 to +125 ±15% according to IEC С X7R ±10% (-25 to +85) $(\pm 10\%)$ -30 to +85+22%,-82% Y5V +80%,-20%

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification,



External electrode I (thick membrane layer)

# ■Capacitance range

For thermal compensation

Part number. MCH18					
Tartiful					
Capacitance(pF)	Temperature characteristics	A(COG)			
	Rated voltage Tolerance (V)	50			
0.5		××××			
0.75 1					
1.1					
1.2		<b>********</b>			
1.3					
1.5 1.6					
1.8		<b>*******</b>			
2 2.2	C(±0.25pF)				
2.4	C(±0.25pF)				
2.7		××××			
3 3.3					
3.6		XXXXXX			
3.9					
4.3					
4.7		<b>*******</b>			
5					
5.1 5.6					
6		×××××			
6.2 6.8					
7	D(±0.5pF)	×××××			
7.5 8	B(±0.5pi /				
8.2					
9					
9.1 10					
11					
12 13					
15		××××			
16 18					
20		××××			
22 24					
27		XXXXXX			
30		<b>******</b>			
33	J(±5%)				
39		******			
43					
47 51		××××			
56		<b>*******</b>			
62 68					
75		<b>******</b>			
82 91					
100					

Part nur	MCH18	
	Temperature characteristics	A(COG)
Capacitance(pF)	Rated voltage (V) Tolerance	50
110		XXXX
120		
130		
150		<b>*****</b>
160		<b>********</b>
180		××××
200		<b>******</b>
220		<b>*****</b>
240		×××××
270		<b>******</b>
300	J(±5%)	
330		×××××
360		
390		
430		
470		
510		
560		EXXXXX
620		××××××
680 750		1000000000000000000000000000000000000
		XXXXXX
820 910		
1,000		
1,000		

Product thickness (mm) 0.8±0.1

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

High dielectric constant

Part number		MCH18					
Capacitance(pF)	Temperature characteristics	C (X7R)		F (Y5V)			
	Rated voltage (V)	50	25	16	50	25	16
	Tolerance	ce K (±10%)			Z (+80, -20%)		
220 270 330							
390 470 560							
680 820 1,000							
1,200 1,500 1,800							
2,200 2,700 3,300							
3,900 4,700 5,600							
6,800 8,200 10,000 (0.01 μF)							
12,000 15,000 18,000					<b>****</b>		
22,000 27,000 33,000							
39,000 47,000 56,000							
68,000 82,000 100,000 (0.1 μF)							××××
120,000 150,000 180,000							<b>****</b>
220,000 270,000 330,000							
390,000 470,000 560,000							
680,000 1,000,000 (1 μF) 1,200,000							
1,500,000 1,800,000 2,200,000							

Product thickness(mm) 0.8±0.1

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

# Characteristics

Class 1 (For thermal compensation)

Temperature characteristics		A (COG)	Test methods / conditions (based on JIS C 5102)		
Item			(based on JIS C 5102)		
Operating temperature		-55°C∼+125°C			
Nominal capacitance (C)		Must be within the specified tolerance range.	Based on paragraph 7.8 and paragraph 9 Measured at room temperature and standard humidity 1000pF or less Measurement frequency: 1±0.1MHz		
Dissipation factor $(\tan \delta)$		100 / (400+20C)% or less (Less than 30 pF) 0.1% or less (30 pF or larger)	Measurement voltage :1±0.1Vrms Over 1000pF Measurement frequency :1±0.1kHz Measurement voltage :1±0.1Vrms		
Insulation resistance (IR)		10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller	Based on paragraph 7.6 Measurement is made after rated voltage is applied for 60±5s.		
Withstanding voltage		The insulation must not be damaged.	Based on paragraph 7.1 Apply 300% of the rated voltage for 1 to 5s then measure.		
Temperature characteristics		Within 0±30ppm / ℃*	The temperature coefficients in table 12, paragraph 7.12 are calculated at 20°C and high temperature.		
Terminal adherence		No detachment or signs of detachment.	Based on paragraph 8.11.2 Apply 5N (0.51 kg · f) for 10±1s in the direction indicated by the arrow.		
	Appearance	There must be no mechanical damage.	Chip is mounted to a board in the		
Resistance to vibration	Rate of capacitance change	Must be within initial tolerance.	to vibration (type A in paragraph 8.2),		
	Tan δ	Must satisfy initial specified value.	and measured 24±2 hrs. later. Board		
Solderability		At least 3 / 4 of the surface of the two terminals must be covered with new solder.	Based on paragraph 8.13 Soldering temperature: 235±5°C Soldering time: 2±0.5s		
	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	$\pm$ 2.5% or less, or $\pm$ 0.25 pF or less, whichever is larger.	Based on paragraph 8.14		
Resistance to soldering	Tan δ	Must satisfy initial specified value.	Soldering temperature : 260±5°C Soldering time : 5±0.5s		
heat	Insulation resistance	10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller	Preheating : 150±10°C for 1 to 2 min.		
	Withstanding voltage	The insulation must not be damaged.	- 1 to 2 mm.		
	Appearance	There must be no mechanical damage.			
Temperature	Rate of capacitance change	$\pm$ 2.5% or less, or $\pm$ 0.25 pF or less, whichever is larger.	Based on paragraph 9.3.		
cycling	Tan δ	Must satisfy initial specified value.	Number of cycles: 10 Capacitance measured after 24±2 hrs.		
	Insulation resistance	10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller			
Humidity load - test	Appearance	There must be no mechanical damage.	Based on paragraph 9.9		
	Rate of capacitance change	$\pm 7.5\%$ or less, or $\pm 0.75$ pF or less, whichever is larger.	Test temperature : 40±2°C Relative humidity : 90% to 95%		
	Tan δ	0.5% or less	Applied voltage : rated voltage Test time : 500 to 524 hrs.		
	Insulation resistance	500 $M\Omega$ or larger, or 25 $\Omega F$ or larger, whichever is smaller	Capacitance measured after 24±2 hrs.		
	Appearance	There must be no mechanical damage.	Record on payagraph 0.10		
High-	Rate of capacitance change	$\pm 3.0\%$ or less, or $\pm 0.3$ pF or less, whichever is larger.	Based on paragraph 9.10 Test temperature : Max. operating temp.		
temperature load test	Tan δ	0.3% or less	Applied voltage : rated voltage x 200% Test time : 1,000 to 1,048 hrs.		
	Insulation resistance	1,000 M $\Omega$ or larger, or 50 $\Omega$ F or larger, whichever is smaller	Capacitance measured after 24±2 hrs.		

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



#### Class 2 (High dielectric constant )

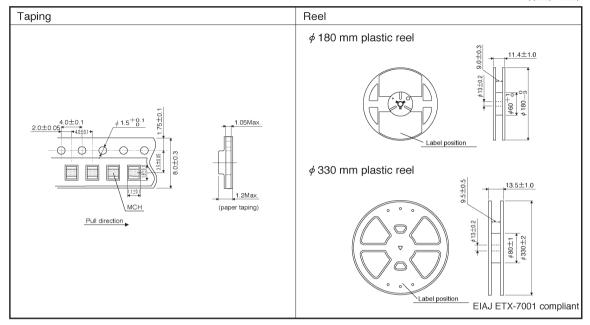
_	lectric constant )	I			
Temperature characteristics		C (X7R)	F (Y5V)	Test methods / conditions (based on JIS C 5102)	
Item				(50350 011010 0 3102)	
Operating temperature		-55°C∼+125°C	-30°C ~+85°C		
Nominal capacitance (C)		Must be within the specified tolerance range.		Based on paragraph 7.8  Measured at room temperature and standard humidit	
$ an \delta$		2.5% or less (when rated voltage is 16V: 3.5% or less)	5.0% or less (when rated voltage is 16V: 7.5% or less)	Measurement frequency: 1 ±0.1 kHz Measurement voltage : 1.0 ±0.2 Vrms.	
Insulation resistance (IR)		10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller		Based on paragraph 7.6 Measurement is made after rated voltage is applied for 60±5s.	
Withstanding voltage		The insulation must not be damaged.		Based on paragraph 7.1 Apply 250% of the rated voltage for 1 to 5s then measure.	
Temperature characteristics		Within ±15%	±22, -82%	The temperature coefficients in paragraph 7.12, table 8, condition B, are based on measurements carried out at 20°C, with no voltage applied.	
Terminal adherence		No detachment or signs of detachment.		Based on paragraph 8.11.2 Apply 5N (0.51 kg • f) for 10±1s in the direction indicated by the arrow.  Pressure (5N) Test board Capacitor	
	Appearance	There must be no mechanical damage.		Chip is mounted to a board in the manner	
Resistance to vibration	Rate of capacitance change	Must be within initial tolerance.		shown on the right, subjected to vibration (type A in paragraph 8.2), and measured	
Dissipation factor		Must satisfy initial specified value.		48±4 hrs. later. Board	
Solderability		At least 3 / 4 of the surface of the two terminals must be covered with new solder.		Based on paragraph 8.13 Soldering temperature : 235 $\pm$ 5 °C Soldering time : 2 $\pm$ 0.5s	
	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	Within ±5.0%	Within ±20.0%	Based on paragraph 8.14	
Resistance to soldering	Dissipation factor	Must satisfy initial specified value.		Soldering temperature : 260±5℃ Soldering time : 5±0.5s	
heat	Insulation resistance	10,000 MΩ or larger, or 500 ΩF or larger, whichever is smaller		Preheating : 150±10°C for 1 to 2 min.	
	Withstanding voltage	The insulation must not be damaged.			
	Appearance	There must be no n			
Temperature	Rate of capacitance change	Within ±7.5%	Within ±20.0%	Based on paragraph 9.3	
cycling	Dissipation factor	Must satisfy initial specified value.		Number of cycles: 10 Capacitance measured after 48 ±4	
	Insulation resistance	10,000 M $\Omega$ or larger, or 500 $\Omega$ F or larger, whichever is smaller			
	Appearance	There must be no n	nechanical damage.	Based on paragraph 9.9	
Humidity load test	Rate of capacitance change	±12.5% or less	Within ±30.0%	Test temperature : 40 ±2℃	
	Dissipation factor	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Relative humidity: 90% to 95% Applied voltage : rated voltage Test time : 500 to 524 hrs.	
	Insulation resistance	500 MΩ or larger, or 25 ΩF of	Capacitance measured after 48 ±		
	Appearance	There must be no n	Pacad on paragraph 0.40		
High-	Rate of capacitance change	Within ±10.0%	Within ±30.0%	Based on paragraph 9.10  Test temperature: Max. operating temp	
temperature load test	Dissipation factor	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Applied voltage :rated voltage x 200% Test time :1,000 to 1,048 hrs. Capacitance measured after 48 ±4 hrs	
	Insulation resistance	1,000M $\Omega$ or larger, or 50 $\Omega$ F or larger, whichever is smaller			

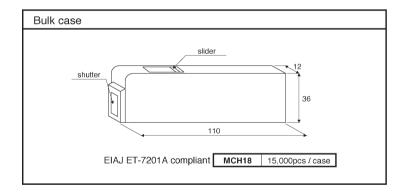
<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



# Packaging specifications

(Units: mm)





<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### Electrical characteristics

## ■A (C0G) Characteristics

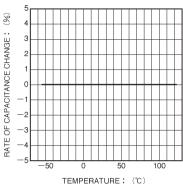


Fig.1 Capacitance —temperature characteristics

# ■C (X7R) Characteristics

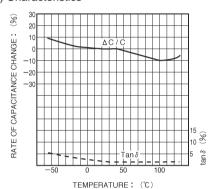


Fig.3 Capacitance — temperature characteristics

#### ■F (Y5V) Characteristics

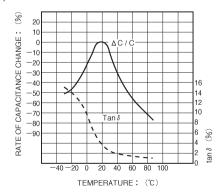


Fig.5 Capacitance —temperature characteristics

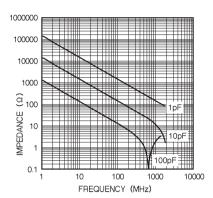


Fig.2 Impedance — frequency characteristics

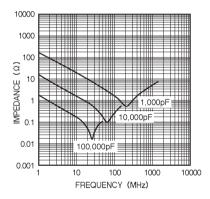


Fig.4 Impedance — frequency characteristics

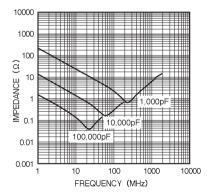
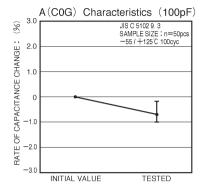


Fig.6 Impedance — frequency characteristics

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

# ■Temperature cycling test



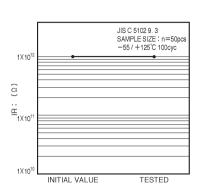
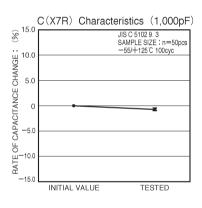
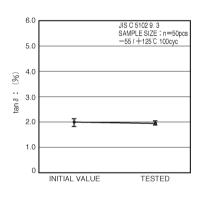


Fig.7 Rate of capacitance change

Fig.8 Tan δ

Fig.9 Insulation resistance





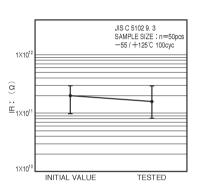
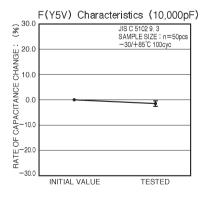
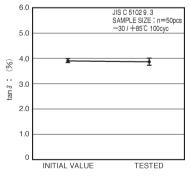


Fig.10 Rate of capacitance change

Fig.11 Tan δ

Fig.12 Insulation resistance





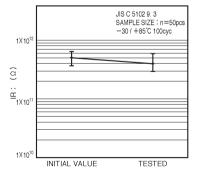


Fig.13 Rate of capacitance change

Fig.14 Tanδ

Fig.15 Insulation resistance

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



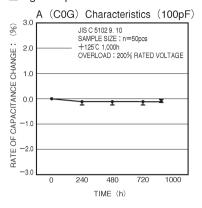


Fig.16 Rate of capacitance change

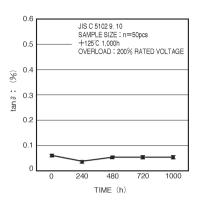


Fig.17 Tan δ

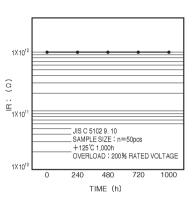


Fig.18 Insulation resistance

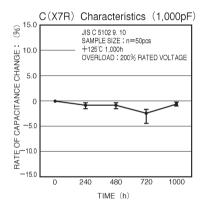


Fig.19 Rate of capacitance change

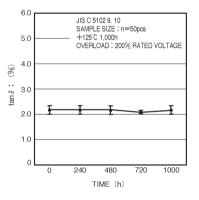


Fig.20 Tan δ

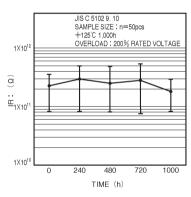


Fig.21 Insulation resistance

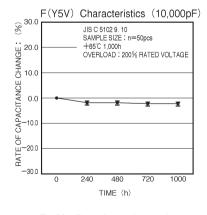


Fig.22 Rate of capacitance change

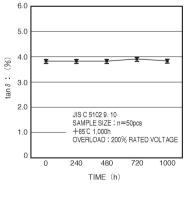


Fig.23 Tanδ

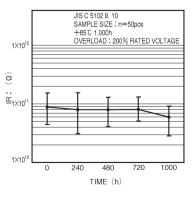
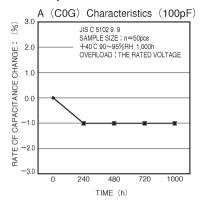


Fig.24 Insulation resistance

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



#### ■Humidty load test



0.6 JIS C 5102 9. 9 SAMPLE SIZE: n=50pcs +40°C 90~95%RH 1,000h 0.5 OVERLOAD : THE RATED VOLTAGE 0.4 8 tan 8: 0.3 0.2 0.1 0 0 240 480 720 1000 TIME (h)

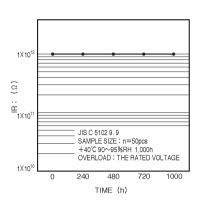
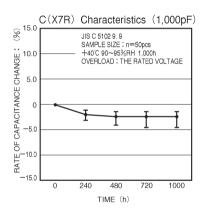
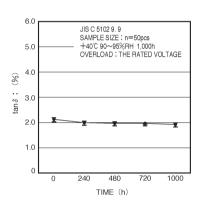


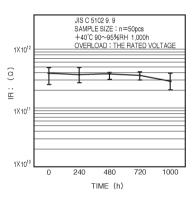
Fig.25 Rate of capacitance change

Fig.26 Tan δ

Fig.27 Insulation resistance







Rate of capacitance change

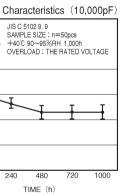


Fig.29 Tan δ

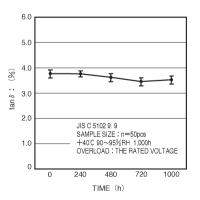


Fig.30 Insulation resistance

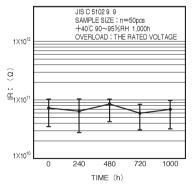


Fig.31 Rate of capacitance change

Fig.32 Tan δ

Insulation resistance

§ 30.0

20.0

10.0

0.0

10.0

-20.0

0

240

RATE OF CAPACITANCE CHANGE:

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.